8-Channel Data Selector

The MC14512B is an 8–channel data selector constructed with MOS P–channel and N–channel enhancement mode devices in a single monolithic structure. This data selector finds primary application in signal multiplexing functions. It may also be used for data routing, digital signal switching, signal gating, and number sequence generation.

- Diode Protection on All Inputs
- Single Supply Operation
- 3-State Output (Logic "1", Logic "0", High Impedance)
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low–power TTL Loads or One Low–power Schottky TTL Load Over the Rated Temperature Range

WAXIMUM RATINGS (Voltages Referenced to V _{SS}) (Note 2.)						
Symbol	Parameter	Value	Unit			
V _{DD}	DC Supply Voltage Range	-0.5 to +18.0	V			
V _{in} , V _{out}	Input or Output Voltage Range (DC or Transient)	-0.5 to V _{DD} + 0.5	V			
I _{in} , I _{out}	Input or Output Current (DC or Transient) per Pin	±10	mA			
P _D	Power Dissipation, per Package (Note NO TAG)	500	mW			
T _A	Ambient Temperature Range	-55 to +125	°C			
T _{stg}	Storage Temperature Range	-65 to +150	°C			
TL	Lead Temperature (8–Second Soldering)	260	°C			

MAXIMUM RATINGS (Voltages Referenced to V_{SS}) (Note 2.)

2. Maximum Ratings are those values beyond which damage to the device may occur.

3. Temperature Derating:

Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C

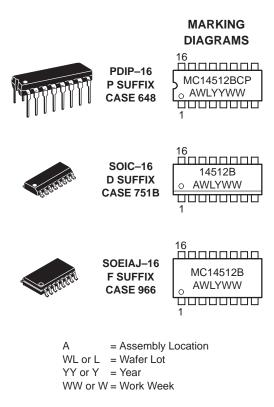
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}.$

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.



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ORDERING INFORMATION

Device	Device Package	
MC14512BCP	PDIP-16	2000/Box
MC14512BD	SOIC-16	48/Rail
MC14512BDR2	SOIC-16	2500/Tape & Reel
MC14512BF	SOEIAJ-16	See Note 1.
MC14512BFL1	SOEIAJ-16	See Note 1.

 For ordering information on the EIAJ version of the SOIC packages, please contact your local ON Semiconductor representative.

С	В	A	Inhibit	Disable	Z				
0	0	0	0	0	X0				
0	0	1	0	0	X1				
0	1	0	0	0	X2				
0	1	1	0	0	X3				
1	0	0	0	0	X4				
1	0	1	0	0	X5				
1	1	0	0	0	X6				
1	1	1	0	0	X7				
Х	Х	Х	1	0	0				
Х	X	X	Х	1	High				
					Impedance				
X = Don't	X = Don't Care								

TRUTH TABLE

PIN ASSIGNMENT

X0 [1•	16	D V _{DD}
X1 [2	15] DIS
X2 [3	14	Dz
X3 [4	13	ВС
X4 [5	12	В
X5 [6	11	D A
X6 [7	10] імн
v _{ss} E	8	9	D X7

ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

Characteristic			V _{DD}	- 5	5°C		25°C		125	5°C	
		Symbol	Vdc	Min	Max	Min	Тур ^(4.)	Max	Min	Max	Unit
Output Voltage $V_{in} = V_{DD} \text{ or } 0$	"0" Level	V _{OL}	5.0 10 15		0.05 0.05 0.05		0 0 0	0.05 0.05 0.05		0.05 0.05 0.05	Vdc
$V_{in} = 0 \text{ or } V_{DD}$	"1" Level	V _{OH}	5.0 10 15	4.95 9.95 14.95		4.95 9.95 14.95	5.0 10 15		4.95 9.95 14.95		Vdc
Input Voltage $(V_O = 4.5 \text{ or } 0.5 \text{ Vdc})$ $(V_O = 9.0 \text{ or } 1.0 \text{ Vdc})$ $(V_O = 13.5 \text{ or } 1.5 \text{ Vdc})$	"0" Level	V _{IL}	5.0 10 15		1.5 3.0 4.0		2.25 4.50 6.75	1.5 3.0 4.0		1.5 3.0 4.0	Vdc
$(V_{O} = 0.5 \text{ or } 4.5 \text{ Vdc})$ $(V_{O} = 1.0 \text{ or } 9.0 \text{ Vdc})$ $(V_{O} = 1.5 \text{ or } 13.5 \text{ Vdc})$	"1" Level	V _{IH}	5.0 10 15	3.5 7.0 11		3.5 7.0 11	2.75 5.50 8.25		3.5 7.0 11		Vdc
$\begin{array}{l} \text{Output Drive Current} \\ (\text{V}_{\text{OH}} = 2.5 \text{ Vdc}) \\ (\text{V}_{\text{OH}} = 4.6 \text{ Vdc}) \\ (\text{V}_{\text{OH}} = 9.5 \text{ Vdc}) \\ (\text{V}_{\text{OH}} = 13.5 \text{ Vdc}) \end{array}$	Source	I _{OH}	5.0 5.0 10 15	- 3.0 - 0.64 - 1.6 - 4.2	 	- 2.4 - 0.51 - 1.3 - 3.4	- 4.2 - 0.88 - 2.25 - 8.8	 	- 1.7 - 0.36 - 0.9 - 2.4	 	mAdc
$(V_{OL} = 0.4 \text{ Vdc})$ $(V_{OL} = 0.5 \text{ Vdc})$ $(V_{OL} = 1.5 \text{ Vdc})$	Sink	I _{OL}	5.0 10 15	0.64 1.6 4.2		0.51 1.3 3.4	0.88 2.25 8.8		0.36 0.9 2.4		mAdc
Input Current		l _{in}	15	—	± 0.1	—	±0.00001	± 0.1	—	± 1.0	μAdc
Input Capacitance (V _{in} = 0)		C _{in}	_	—	—	—	5.0	7.5	—	—	pF
Quiescent Current (Per Package)		I _{DD}	5.0 10 15		5.0 10 20		0.005 0.010 0.015	5.0 10 20		150 300 600	μAdc
Total Supply Current ^(5.) (6 (Dynamic plus Quiesce Per Package) ($C_L = 50 \text{ pF}$ on all outp buffers switching)	ent,	Ι _Τ	5.0 10 15			I _T = (1	 0.8 μΑ/kHz) f 6 μΑ/kHz) f 2.4 μΑ/kHz) f	+ I _{DD}			μAdc
Three–State Leakage Cur	rent	I _{TL}	15	—	± 0.1	—	± 0.0001	± 0.1	—	± 3.0	μAdc

Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.
 The formulas given are for the typical characteristics only at 25°C.
 To calculate total supply current at loads other than 50 pF:

 $I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$

where: I_T is in μA (per package), C_L in pF, $V = (V_{DD} - V_{SS})$ in volts, f in kHz is input frequency, and k = 0.001.

SWITCHING CHARACTERISTICS (7.) (CL = 50 pF, TA = 25° C, See Figure 1)

			All Types		
Characteristic	Symbol	V _{DD}	Тур (8.)	Max	Unit
Output Rise and Fall Time t_{TLH} , $t_{THL} = (1.5 \text{ ns/pF}) C_L + 25 \text{ ns}$ t_{TLH} , $t_{THL} = (0.75 \text{ ns/pF}) C_L + 12.5 \text{ ns}$ t_{TLH} , $t_{THL} = (0.55 \text{ ns/pF}) C_L + 9.5 \text{ ns}$	t _{TLH} , t _{THL}	5.0 10 15	100 50 40	200 100 80	ns
Propagation Delay Time (Figure 2) Inhibit, Control, or Data to Z	t _{PLH}	5.0 10 15	330 125 85	650 250 170	ns
Propagation Delay Time (Figure 2) Inhibit, Control, or Data to Z	t _{PHL}	5.0 10 15	330 125 85	650 250 170	ns
3–State Output Delay Times (Figure 3) "1" or "0" to High Z, and High Z to "1" or "0"	t _{PHZ} , t _{PLZ} , t _{PZH} , t _{PZL}	5.0 10 15	60 35 30	150 100 75	ns

The formulas given are for the typical characteristics only at 25°C.
 Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

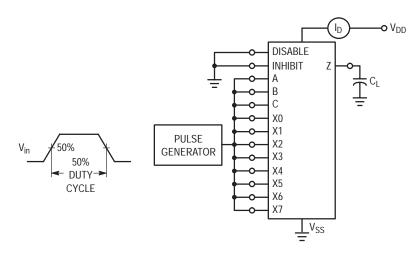


Figure 1. Power Dissipation Test Circuit and Waveform

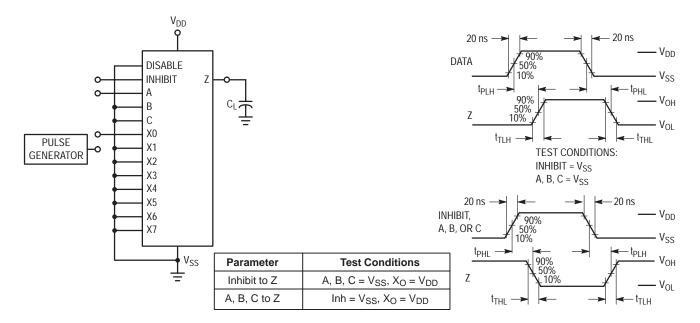


Figure 2. AC Test Circuit and Waveforms

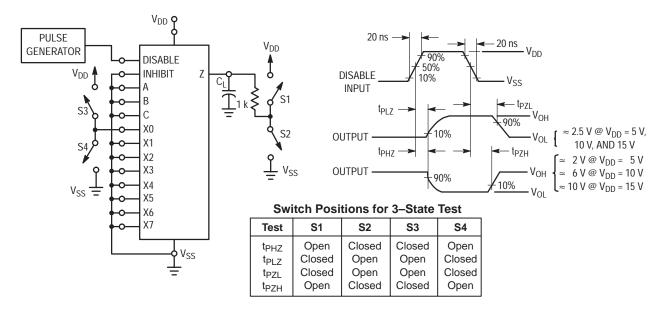
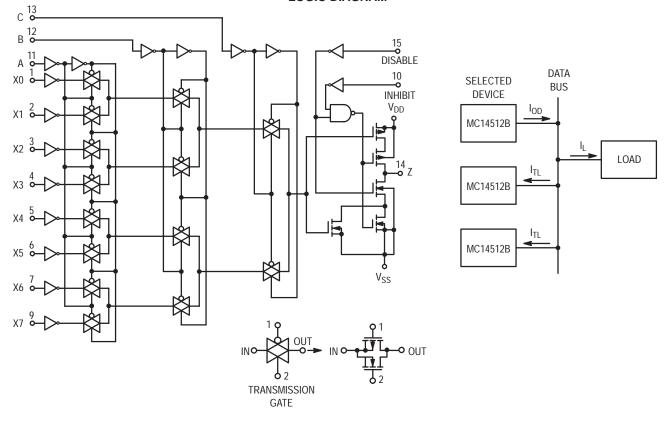


Figure 3. 3–State AC Test Circuit and Waveform

LOGIC DIAGRAM



3-STATE MODE OF OPERATION

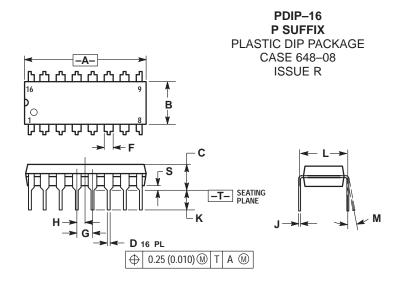
Output terminals of several MC14512B 8–Bit Data Selectors can be connected to a single date bus as shown. One MC14512B is selected by the 3–state control, and the remaining devices are disabled into a high–impedance "off" state. The number of 8–bit data selectors, N, that may be connected to a bus line is determined from the output drive current, I_{OD} , 3–state or disable output leakage current, I_{TL} , and the load current, I_L , required to drive the bus line

(including fanout to other device inputs), and can be calculated by:

$$N = \frac{I_{OD} - I_L}{I_{TL}} + 1$$

N must be calculated for both high and low logic state of the bus line.

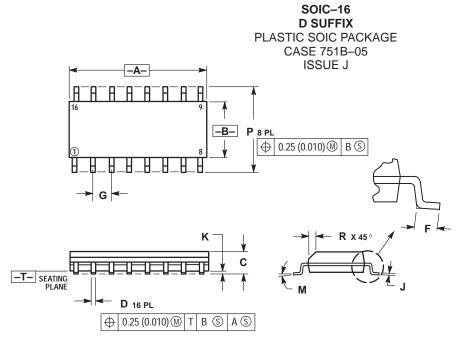
PACKAGE DIMENSIONS



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 5. ROUNDED CORNERS OPTIONAL.

NOTES:

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN MAX		
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02 1.7		
G	0.100	BSC	2.54 BSC		
Н	0.050 BSC		1.27 BSC		
J	0.008	0.015	0.21	0.38	
К	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50 7.7		
М	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51 1.01		



NOTES:

 NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.

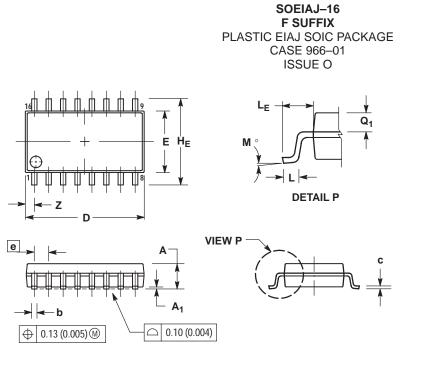
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006)

PER SIDE. 5. DIMENSION D DOES NOT INCLUDE DAMBAR

PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	9.80	10.00	0.386	0.393
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050	BSC
J	0.19	0.25	0.008	0.009
Κ	0.10	0.25	0.004	0.009
М	0 °	7°	0 °	7°
Р	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

PACKAGE DIMENSIONS



NOTES

DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982

CONTROLLING DIMENSION: MILLIMETER.

B. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE. . TERMINAL NUMBERS ARE SHOWN FOR

REFERENCE ONLY. THE LEAD WIDTH DIMENSION (b) DOES NOT 5 INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α		2.05		0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
С	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27	BSC	0.050 BSC	
H _E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
LE	1.10	1.50	0.043	0.059
М	0 °	10 °	0 °	10 °
Q ₁	0.70	0.90	0.028	0.035
Ζ		0.78		0.031

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